## **CLAIMS**

## WHAT IS CLAIMED:

1. A method, comprising:

providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks, said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic;

providing a substrate having at least one grating structure formed thereabove, said formed grating structure comprised of a plurality of gate stacks;

illuminating said at least one grating structure formed above said substrate;

measuring light reflected off of said at least one grating structure formed above said substrate to generate an optical characteristic trace for said formed grating structure; and

comparing said generated optical characteristic trace to said target trace.

2. The method of claim 1, wherein providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks, said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic, comprises:

generating a plurality of optical characteristic traces for a plurality of grating structures comprised of a plurality of gate stacks;

generating electrical test data for at least one semiconductor device; and

correlating at least one of said plurality of optical characteristic traces with said electrical test data to determine a target optical characteristic trace that

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corresponds to a semiconductor device having at least one desired electrical performance characteristic.

- 3. The method of claim 1, further comprising adjusting at least one parameter of at least one process used to form gate stack on a subsequently processed wafer based upon said comparison of said generated trace and said target trace.
- 4. The method of claim 1, further comprising adjusting at least one parameter of at least one process operation to be performed on said provided substrate based upon a deviation between said generated trace and said target trace.
- 5. The method of claim 1, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a scribe line of said substrate.
- 6. The method of claim 1, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a production die formed above said substrate.
- 7. The method of claim 1, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having a plurality of grating structures formed thereabove.
- 8. The method of claim 1, wherein said grating structure formed above said provided substrate is formed in an area having dimensions of approximately  $100 \times 120 \,\mu m$ .

- 9. The method of claim 1, wherein said at least one desired electrical performance characteristic comprises at least one of a drive current and an operating frequency.
  - 10. A method, comprising:

providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks, said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic;

providing a silicon substrate having at least one grating structure formed thereabove, said formed grating structure comprised of a plurality of gate stacks;

illuminating said at least one grating structure formed above said substrate;

measuring light reflected off of said at least one grating structure formed above said substrate to generate an optical characteristic trace for said formed grating structure;

comparing said generated optical characteristic trace to said target trace; and adjusting at least one parameter of at least one process used to form a gate stack on a subsequently processed wafer based upon said comparison of said generated trace and said target trace.

11. The method of claim 10, wherein providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks, said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic, comprises:

generating a plurality of optical characteristic traces for a plurality of grating structures comprised of a plurality of gate stacks;

generating electrical test data for at least one semiconductor device; and

- correlating at least one of said plurality of optical characteristic traces with said electrical test data to determine a target optical characteristic trace that corresponds to a semiconductor device having at least one desired electrical performance characteristic.
- 12. The method of claim 10, further comprising adjusting at least one parameter of at least one process operation to be performed on said provided substrate based upon a deviation between said generated trace and said target trace.
- 13. The method of claim 10, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a scribe line of said substrate.
- 14. The method of claim 10, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a production die formed above said substrate.
- 15. The method of claim 10, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having a plurality of grating structures formed thereabove.

- 16. The method of claim 10, wherein said grating structure formed above said provided substrate is formed in an area having dimensions of approximately  $100 \times 120 \,\mu m$ .
- 17. The method of claim 10, wherein said at least one desired electrical performance characteristic comprises at least one of a drive current and an operating frequency.
  - 18. A method, comprising:
  - providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks, said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic;
  - providing a silicon substrate having at least one grating structure formed thereabove, said formed grating structure comprised of a plurality of gate stacks; illuminating said at least one grating structure formed above said substrate;
  - measuring light reflected off of said at least one grating structure formed above said substrate to generate an optical characteristic trace for said formed grating structure;
  - comparing said generated optical characteristic trace to said target trace; and adjusting at least one parameter of at least one process operation to be performed on said provided substrate based upon a deviation between said generated trace and said target trace.
- 19. The method of claim 18, wherein providing a library comprised of at least one target optical characteristic trace of a grating structure comprised of a plurality of gate stacks,

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said target trace corresponding to a semiconductor device having at least one desired electrical performance characteristic, comprises:

generating a plurality of optical characteristic traces for a plurality of grating structures comprised of a plurality of gate stacks;

generating electrical test data for at least one semiconductor device; and

correlating at least one of said plurality of optical characteristic traces with said electrical test data to determine a target optical characteristic trace that corresponds to a semiconductor device having at least one desired electrical performance characteristic.

- 20. The method of claim 18, further comprising adjusting at least one parameter of at least one process used to form a gate stack on a subsequently processed wafer based upon said comparison of said generated trace and said target trace.
- 21. The method of claim 18, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a scribe line of said substrate.
- 22. The method of claim 18, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having at least one grating structure formed in a production die formed above said substrate.
- 23. The method of claim 18, wherein providing a substrate having at least one grating structure formed thereabove comprises providing a substrate having a plurality of grating structures formed thereabove.

- 24. The method of claim 18, wherein said grating structure formed above said provided substrate is formed in an area having dimensions of approximately  $100 \times 120 \ \mu m$ .
- 25. The method of claim 18, wherein said at least one desired electrical performance characteristic comprises at least one of a drive current and an operating frequency.